

HMBT2907 / HMBT2907A

General Purpose Transistor PNP Silicon

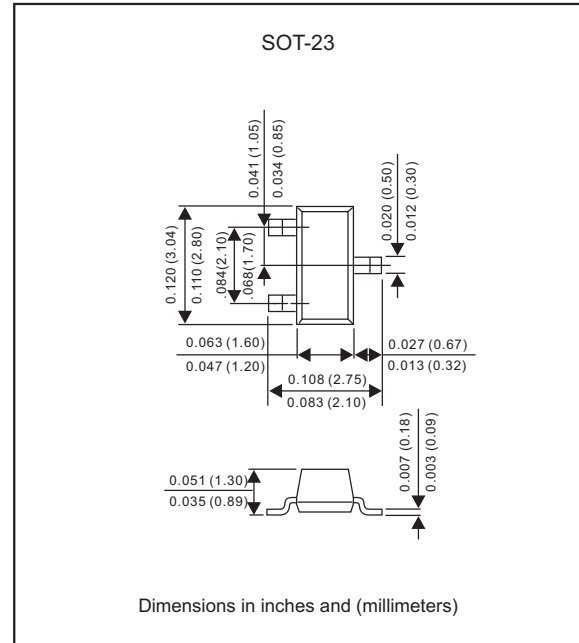
Features

- High collector-emitter breakdown voltage
- PNP silicon epitaxial planar transistor, is designed for general purpose and amplifier applications
- Capable of 225mW power dissipation
- Lead-free parts meet RoHS requirements
- Suffix "-H" indicates Halogen-free part, ex. HMBT2907-H

Mechanical data

- Epoxy: UL94-V0 rated flame retardant
- Case : Molded plastic, SOT-23
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
- Mounting Position : Any
- Weight : Approximated 0.008 gram

Package outline



Maximum ratings (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	HMBT2907	HMBT2907A	Unit
Collector-emitter voltage	V_{CEO}	-40	-60	V
Collector-base voltage	V_{CBO}	-60		V
Emitter-base voltage	V_{EBO}	-5.0		V
Collector current - continuous	I_C	-600		mA
Total device dissipation FR-5 board (1)	P_D	$T_A = 25^\circ\text{C}$	225	mW
		Derate above 25°C	1.8	mW/ $^\circ\text{C}$
Thermal resistance	$R_{\theta JA}$	556		$^\circ\text{C}/\text{W}$
Total device dissipation alumina substrate(2)	P_D	$T_A = 25^\circ\text{C}$	300	mW
		Derate above 25°C	2.4	mW/ $^\circ\text{C}$
Thermal resistance	$R_{\theta JA}$	417		$^\circ\text{C}/\text{W}$
Operating junction temperature range	T_J	-55 to +150		$^\circ\text{C}$
Storage temperature range	T_{STG}	-55 to +150		$^\circ\text{C}$

1. FR-5 = 1.0 X 0.75 X 0.062 in.

2. Alumina = 0.4 X 0.3 X 0.024 in. 99.5% alumina.

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Electrical characteristics (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

Off characteristics

Parameter	Conditions	Symbol	MIN.	TYP.	MAX.	Unit
Collector-emitter breakdown voltage (2)	$I_C = -10\text{mA}$, $I_B = 0$ HMBT2907 HMBT2907A	$V_{(BR)CEO}$	-40 -60			V
Collector-base breakdown voltage	$I_C = -10\mu\text{A}$, $I_E = 0$	$V_{(BR)CBO}$	-60			V
Emitter-base breakdown voltage	$I_E = -10\mu\text{A}$, $I_C = 0$	$V_{(BR)EBO}$	-5.0			V
Collector cutoff current	$V_{CB} = -30\text{V}$, $I_{BE(off)} = -0.5\text{V}$	I_{CEX}			-50	nA
Collector cutoff current	$V_{CB} = -50\text{V}$, $I_E = 0$ HMBT2907 HMBT2907A	I_{CBO}			-0.02 -0.01	μA
	$V_{CB} = -50\text{V}$, $I_E = 0$, $T_A = 125^\circ\text{C}$ HMBT2907 HMBT2907A				-20 -10	
Base current	$V_{CE} = -30\text{V}$, $V_{EB(off)} = -0.5\text{V}$	I_B			-50	nA

On characteristics

Parameter	Conditions	Symbol	MIN.	TYP.	MAX.	Unit
DC current gain	$I_C = -0.1\text{mA}$, $V_{CE} = -10\text{V}$ HMBT2907 HMBT2907A	h_{FE}	35 75			
	$I_C = -1.0\text{mA}$, $V_{CE} = -10\text{V}$ HMBT2907 HMBT2907A		50 100			
	$I_C = -10\text{mA}$, $V_{CE} = -10\text{V}$ HMBT2907 HMBT2907A		75 100			
	$I_C = -150\text{mA}$, $V_{CE} = -10\text{V}$ (2) HMBT2907 HMBT2907A		- 100		-	300
	$I_C = -500\text{mA}$, $V_{CE} = -10\text{V}$ (2) HMBT2907 HMBT2907A		30 50			
Collector-emitter saturation voltage (2)	$I_C = -150\text{mA}$, $I_B = -15\text{mA}$	$V_{CE(sat)}$			-0.4	V
	$I_C = -500\text{mA}$, $I_B = -50\text{mA}$				-1.6	
Base-emitter saturation voltage (2)	$I_C = -150\text{mA}$, $I_B = -15\text{mA}$	$V_{BE(sat)}$			-1.3	V
	$I_C = -500\text{mA}$, $I_B = -50\text{mA}$				-2.6	

Small-signal characteristics

Parameter	Conditions	Symbol	MIN.	TYP.	MAX.	Unit
Current-gain-bandwidth produc (2,3)	$I_C = -50\text{mA}$, $V_{CE} = -20\text{V}$, $f = 100\text{MHz}$	f_r	200			MHz
Output capacitance	$V_{CB} = -10\text{V}$, $I_E = 0$, $f = 1.0\text{MHz}$	C_{obo}			8.0	pF
Input capacitance	$V_{EB} = -2.0\text{V}$, $I_C = 0$, $f = 1.0\text{MHz}$	C_{ibo}			30	pF

Switching characteristics

Parameter	Conditions	Symbol	MIN.	TYP.	MAX.	Unit
Turn-on time	$V_{CC} = -30\text{V}$, $I_C = -150\text{mA}$, $I_{B1} = -15\text{mA}$	t_{on}			45	ns
Delay time		t_d			10	
Rise time		t_r			40	
Storage time	$V_{CC} = -6.0\text{V}$, $I_C = -150\text{mA}$, $I_{B1} = I_{B2} = -15\text{mA}$	t_s			225	
Fall time		t_f			60	
Turn-off time		t_{off}			280	

2. Pulse test : pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2.0\%$.

3. f_r is defined as the frequency at which $|h_{fe}|$ extrapolates to unity.

Rating and characteristic curves (HMBT2907 / HMBT2907A)

Figure 1. Delay and Rise Time Test Circuit

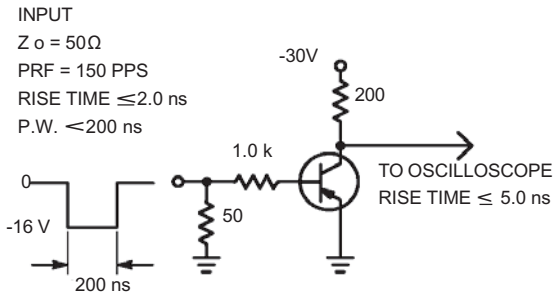


Figure 2. Storage and Fall Time Test Circuit

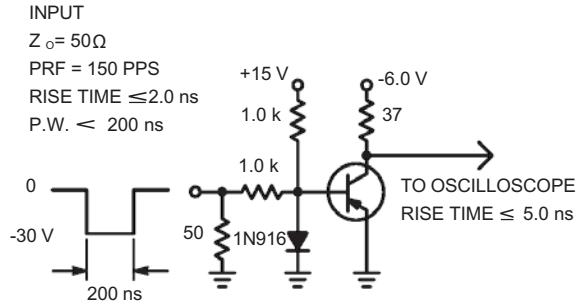


Figure 3. DC Current Gain

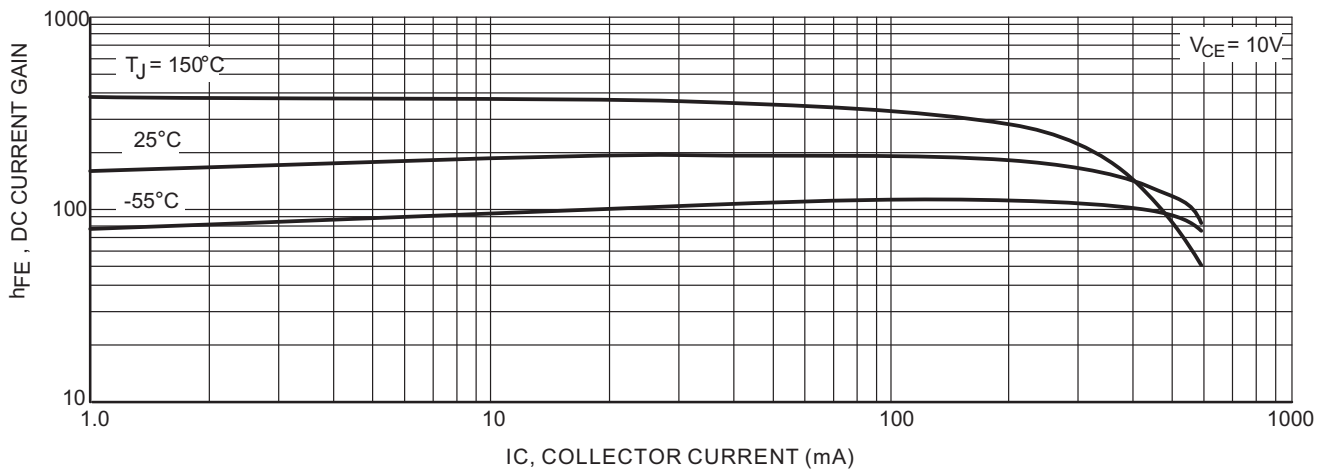
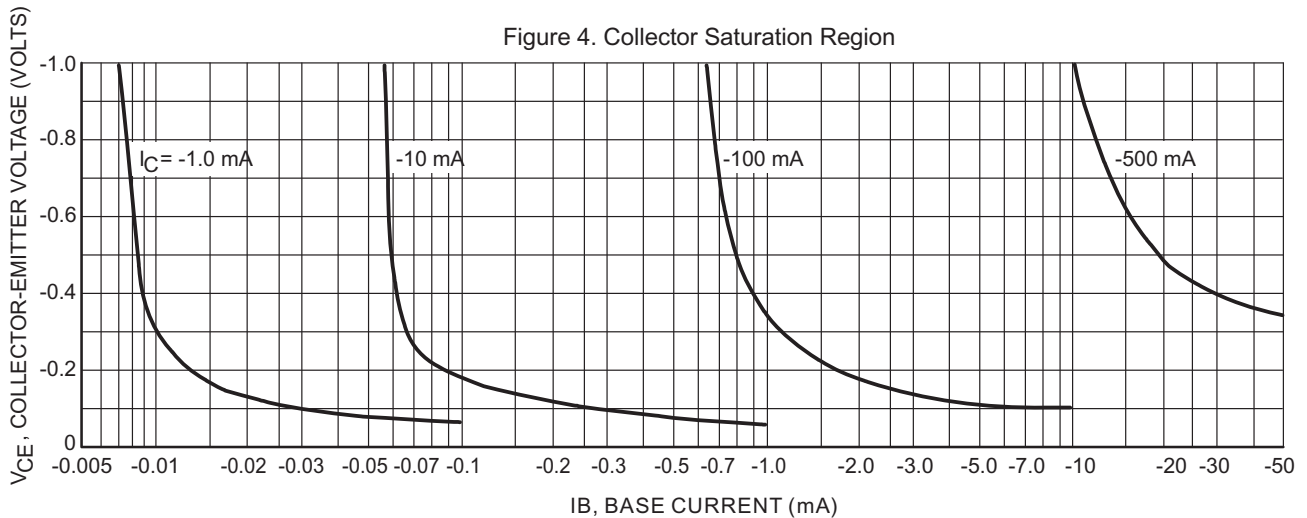


Figure 4. Collector Saturation Region



Rating and characteristic curves (HMBT2907 / HMBT2907A)

Figure 5. Turn-on Time

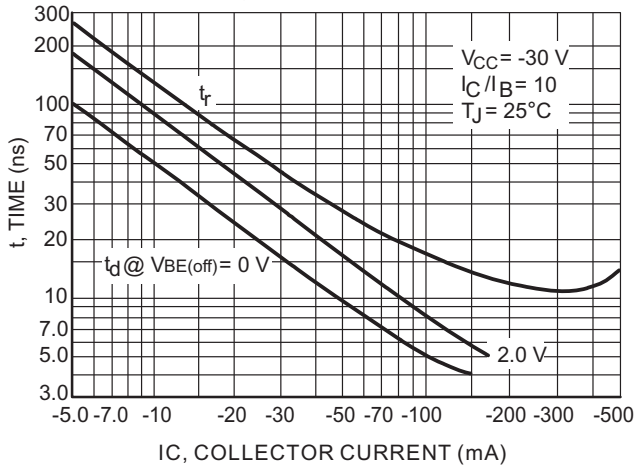
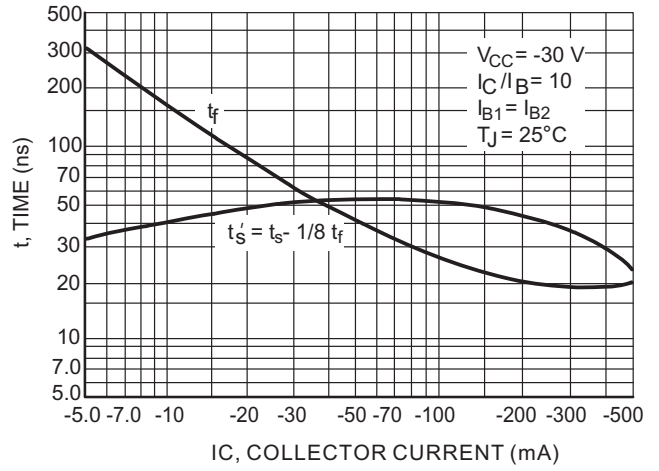


Figure 6. Turn-off Time



Rating and characteristic curves (HMBT2907 / HMBT2907A)

TYPICAL SMALL-SIGNAL CHARACTERISTICS

NOISE FIGURE

$V_{CE} = 10 \text{ Vdc}$, $T_A = 25^\circ\text{C}$

Figure 7. Frequency Effects

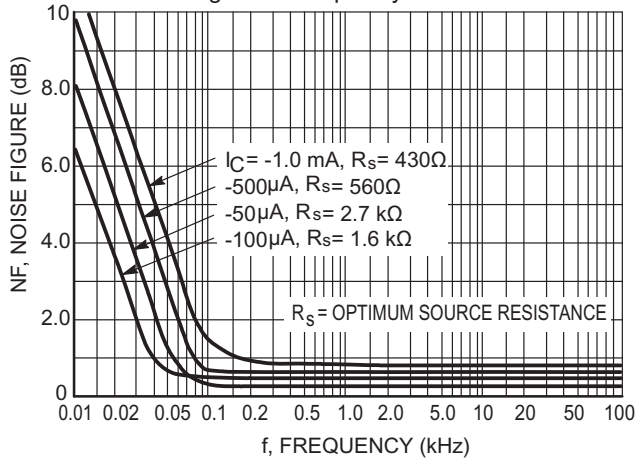


Figure 8. Source Resistance Effects

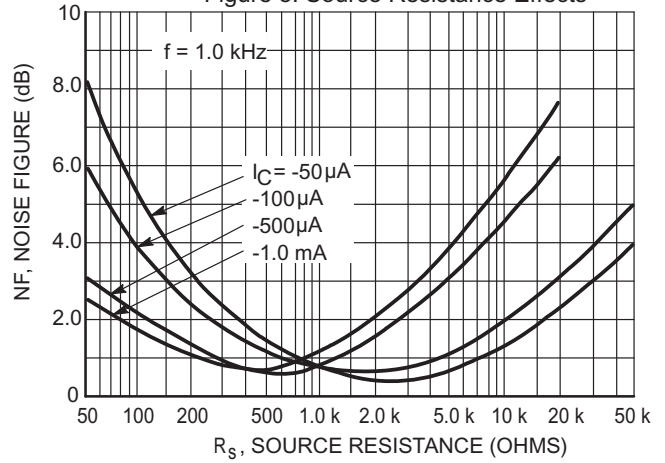


Figure 9. Capacitances

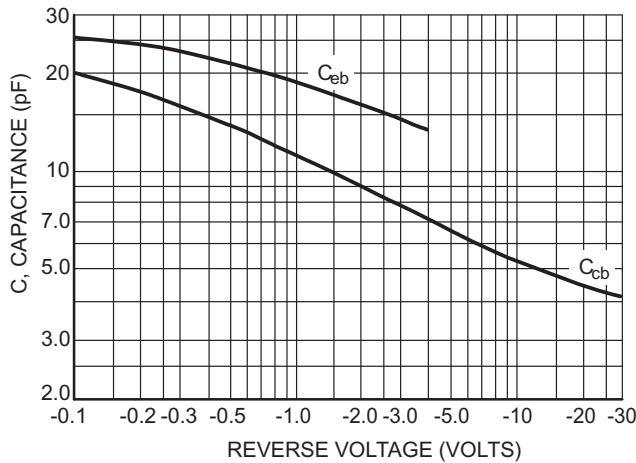


Figure 10. Current-Gain - Bandwidth Product

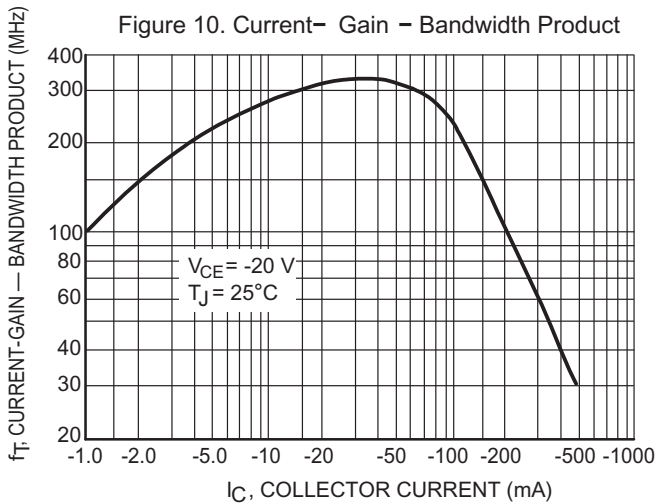


Figure 11. Collector Emitter Saturation Voltage vs. Collector Current

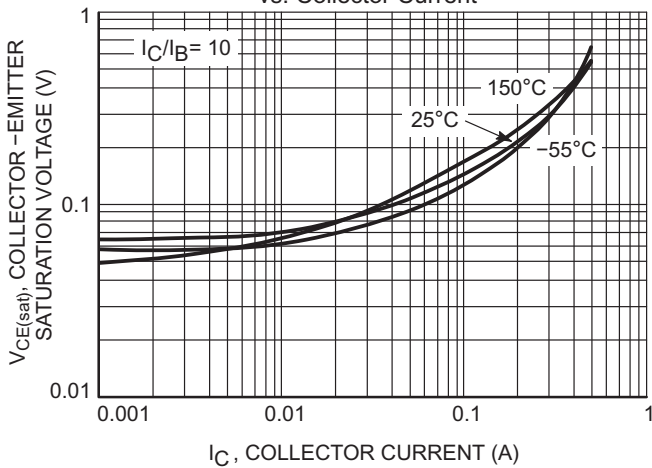
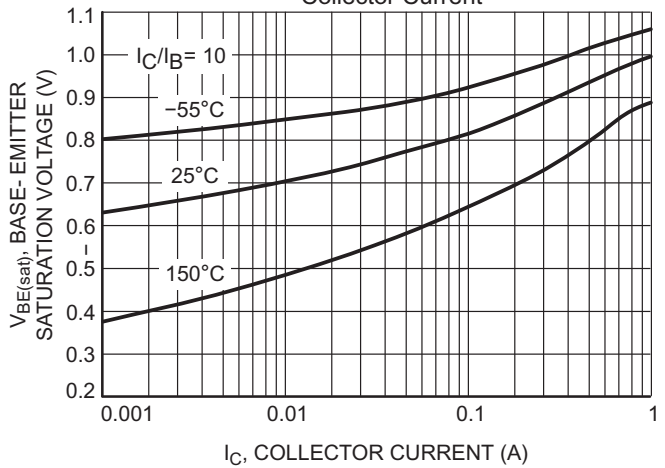


Figure 12. Base Emitter Saturation Voltage vs. Collector Current



Rating and characteristic curves (HMBT2907 / HMBT2907A)

TYPICAL SMALL-SIGNAL Characteristics NOISE FIGURE

$V_{CE} = 10 \text{ Vdc}$, $T_A = 25^\circ\text{C}$

Figure 13. Base Emitter Voltage vs. Collector Current

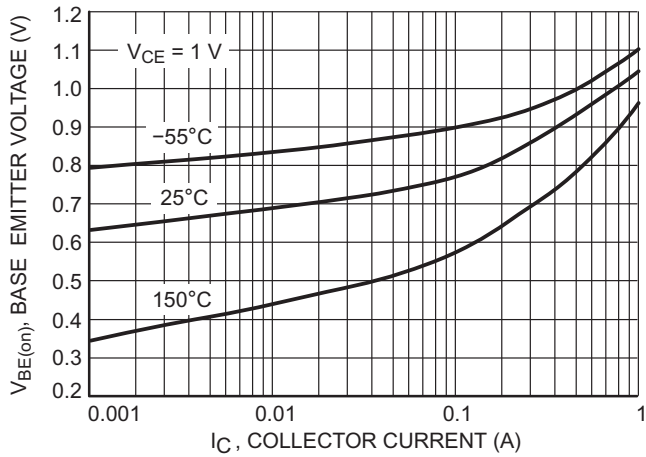


Figure 14. Temperature Coefficients

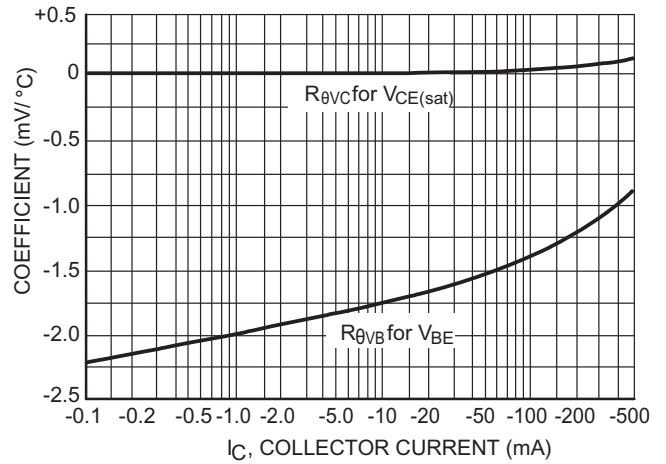
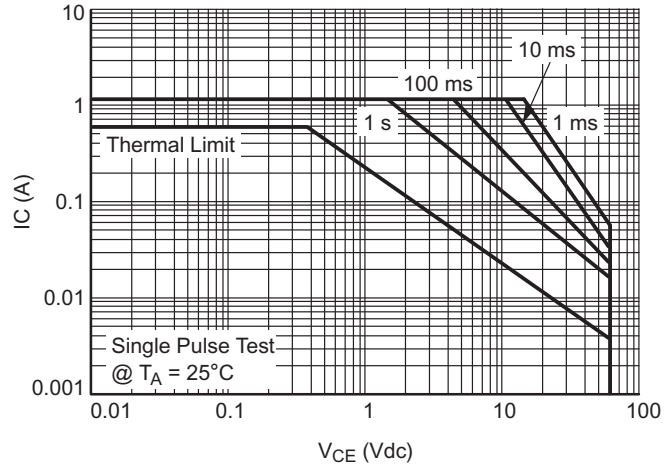
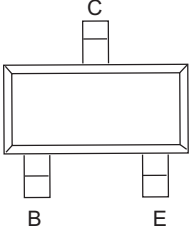
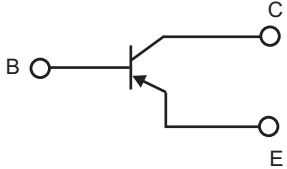


Figure 15. Safe Operating Area



HMBT2907 / HMBT2907A

Pinning information

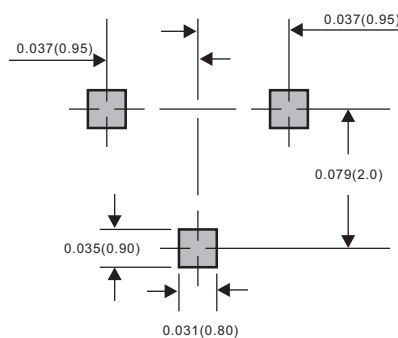
Pin	Simplified outline	Symbol
PinB Base PinC Collector PinE Emitter		

Marking

Type number	Marking code
HMBT2907	M2B
HMBT2907A	2F

Suggested solder pad layout

SOT-23



Dimensions in inches and (millimeters)